

## Features

Type	V <sub>DSS</sub>	R <sub>D(on)</sub> max	I <sub>D</sub>
STS2DNF30L	30V	<0.11Ω	3A

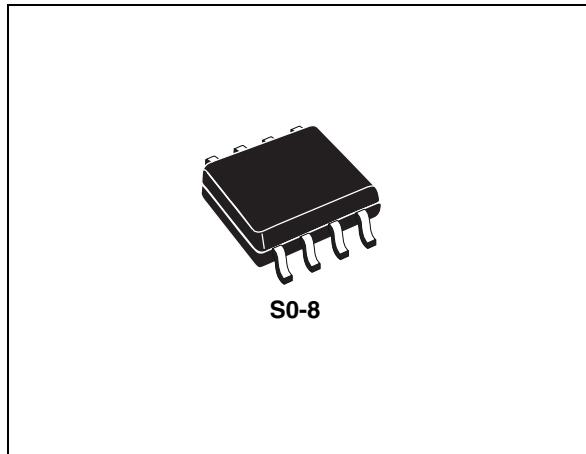
- Standard outline for easy automated surface mount assembly
- Low threshold gate drive

## Application

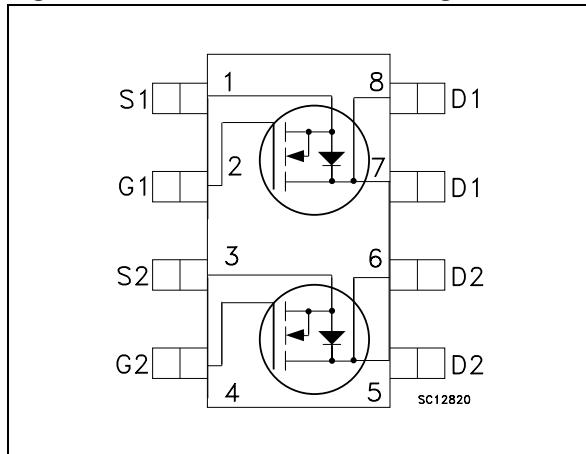
- Switching applications

## Description

This Power MOSFET is the latest development of STMicroelectronics unique "single feature size" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.



**Figure 1. Internal schematic diagram**



**Table 1. Device summary**

Order code	Marking	Package	Packaging
STS2DNF30L	2DF30L	SO-8	Tape and reel

## Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage ( $v_{gs} = 0$ )	30	V
$V_{GS}$	Gate- source voltage	$\pm 18$	V
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	3	A
$I_D$	Drain current (continuous) at $T_C = 100^\circ\text{C}$	1.9	A
$I_{DM}^{(1)}$	Drain current (pulsed)	9	A
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$ dual operation	1.6	W
	Total dissipation at $T_C = 25^\circ\text{C}$ single operation	2	W
$T_{stg}$	Storage temperature	-55 to 150	$^\circ\text{C}$
$T_j$	Max. operating junction temperature	150	$^\circ\text{C}$

1. Pulse width limited by safe operating area

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-a}$	Thermal resistance junction-ambient max single operation	62.5	$^\circ\text{C}/\text{W}$
	Thermal resistance junction-ambient max dual operation	78	
$T_J$	Maximum operating junction ambient	150	$^\circ\text{C}$
$T_{stg}$	Storage temperature	-55 to 175	$^\circ\text{C}$

## 2 Electrical characteristics

( $T_{CASE}=25^\circ\text{C}$  unless otherwise specified)

**Table 4. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source Breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	30			V
$I_{DSS}$	Zero gate voltage Drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max rating}$ $V_{DS}=\text{Max rating}, T_C=125^\circ\text{C}$			1 10	$\mu\text{A}$ $\mu\text{A}$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 18\text{V}$			$\pm 100$	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	1	1.7	2.5	V
$R_{DS(\text{on})}$	Static drain-source on resistance	$V_{GS} = 10\text{V}, I_D = 1\text{A}$ $V_{GS} = 5\text{V}, I_D = 1\text{A}$		0.09 0.13	0.11 0.15	$\Omega$ $\Omega$

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$g_{fs}$ (1)	Forward transconductance	$V_{DS}>I_{D(\text{on})}\times R_{DS(\text{on})\text{max}}$ $I_D=2.5\text{A}$	-	2.5	-	S
$C_{iss}$	Input capacitance			121		pF
$C_{oss}$	Output capacitance	$V_{DS} = 25\text{V}, f = 1 \text{ MHz}, V_{GS} = 0$	-	45	-	pF
$C_{rss}$	Reverse transfer capacitance			11		pF
$Q_g$	Total gate charge		-	4.5	-	nC
$Q_{gs}$	Gate-source charge	$V_{DD} = 24\text{V}, I_D = 2\text{A}, V_{GS} = 10\text{V}$	-	1.7	-	nC
$Q_{gd}$	Gate-drain charge		-	0.9	-	nC

1. Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5.

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(\text{on})}$ $t_r$	Turn-on delay time Rise time	$V_{DD}=15 \text{ V}, I_D=1\text{A}, R_G=4.7\Omega, V_{GS}=4.5\text{V}$ (see Figure 13)	-	19 20	-	ns ns
$t_{d(\text{off})}$ $t_f$	Turn-off delay time Fall time	$V_{DD}=15 \text{ V}, I_D=1\text{A}, R_G=4.7\Omega, V_{GS}=4.5\text{V}$ (see Figure 13)	-	12 8	-	ns ns

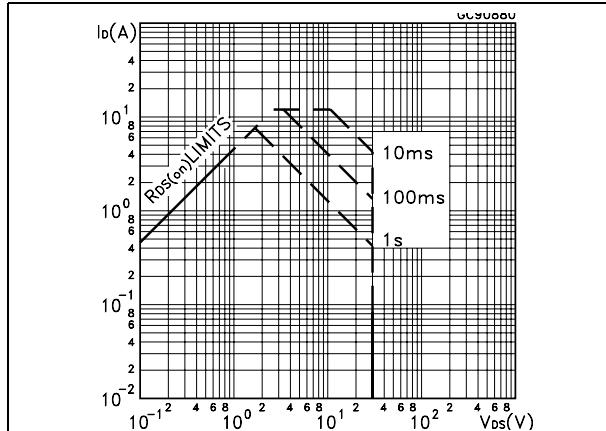
**Table 7. Source drain diode**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max</b>	<b>Unit</b>
$I_{SD}$	Source-drain current		-		3	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)		-		12	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 2A, V_{GS} = 0$	-		1.3	V
$t_{rr}$ $Q_{rr}$ $I_{RRM}$	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 2A, V_{DD} = 30V$ $di/dt = 100A/\mu s$ , $T_j = 150^\circ C$ (see Figure 15)	-	19 8.1 0.85		ns nC A

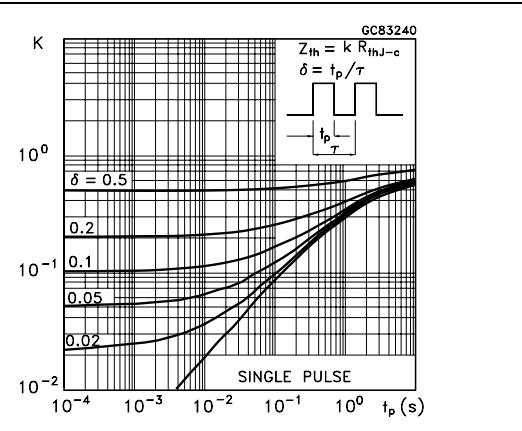
1. Pulse width limited by safe operating area.  
 2. Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

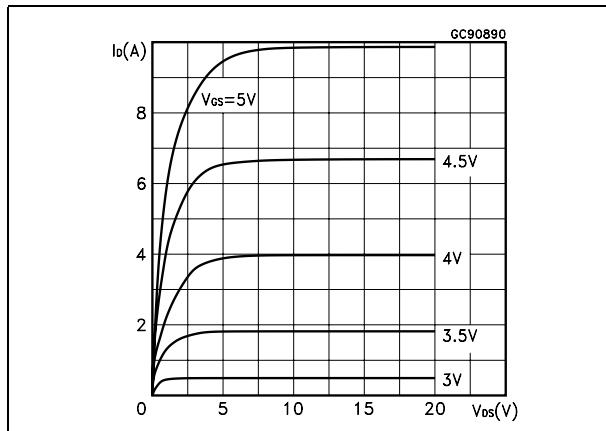
**Figure 2. Safe operating area**



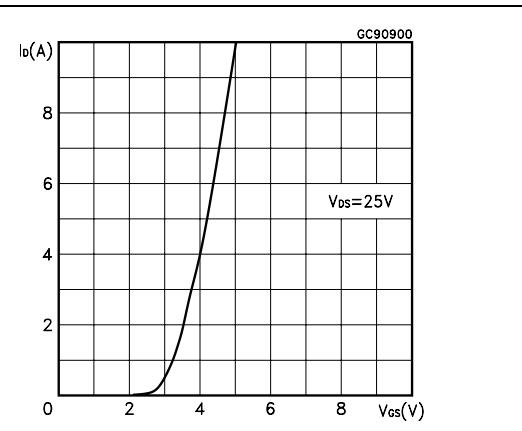
**Figure 3. Thermal impedance**



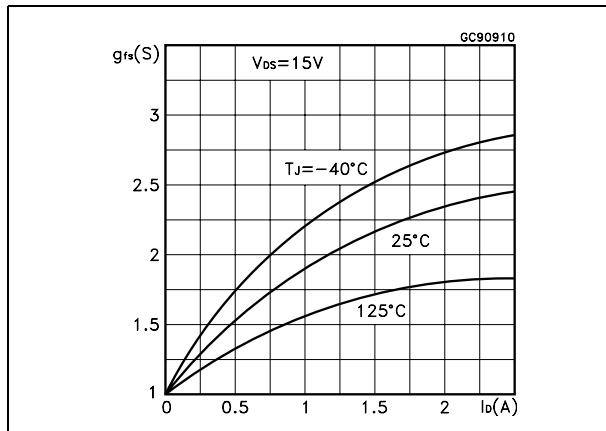
**Figure 4. Output characteristics**



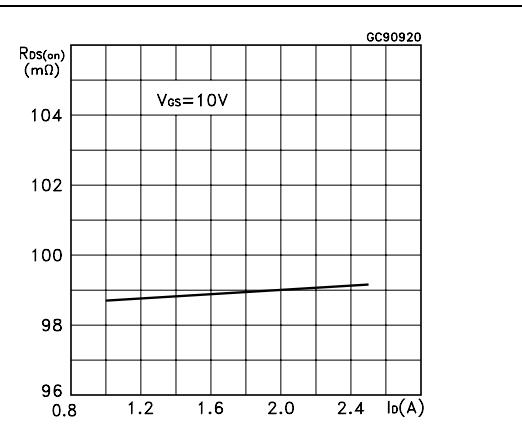
**Figure 5. Transfer characteristics**

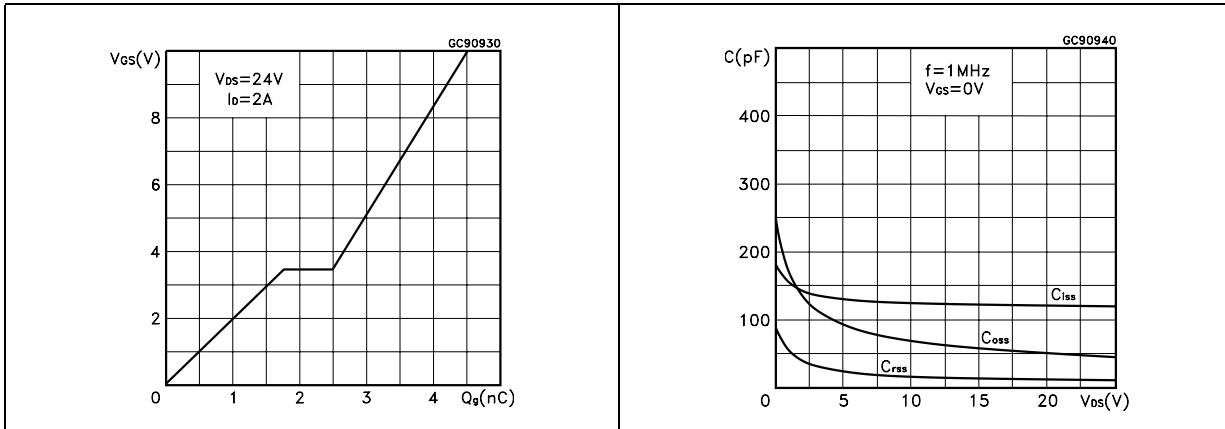
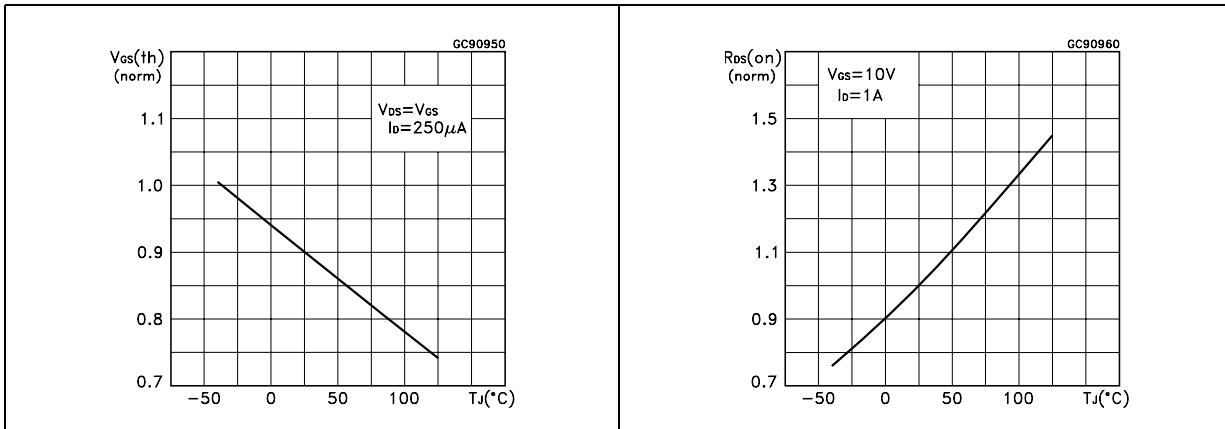
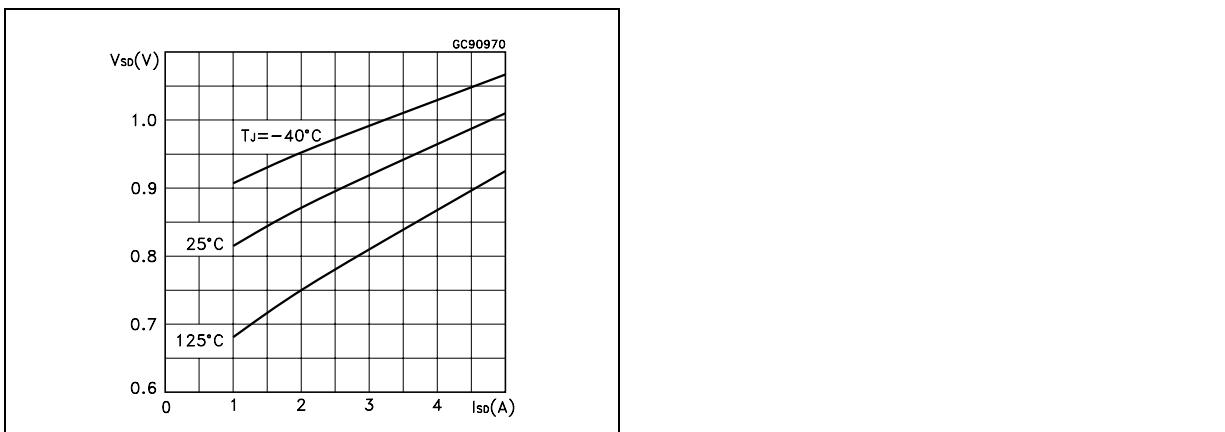


**Figure 6. Transconductance**



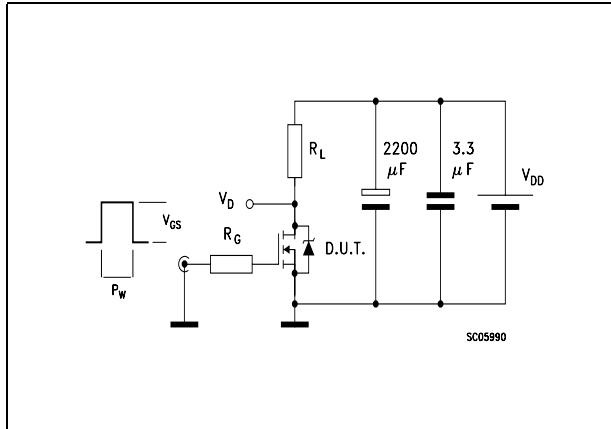
**Figure 7. Static drain-source on resistance**



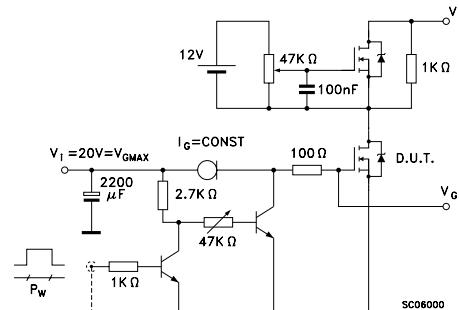
**Figure 8. Gate charge vs. gate-source voltage****Figure 10. Normalized gate threshold voltage vs. temperature****Figure 12. Source-drain diode forward characteristics**

### 3 Test circuits

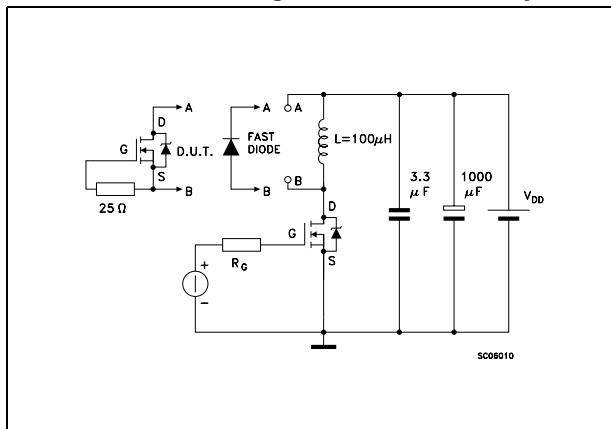
**Figure 13. Switching times test circuit for resistive load**



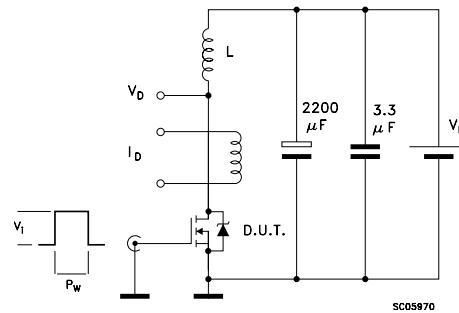
**Figure 14. Gate charge test circuit**



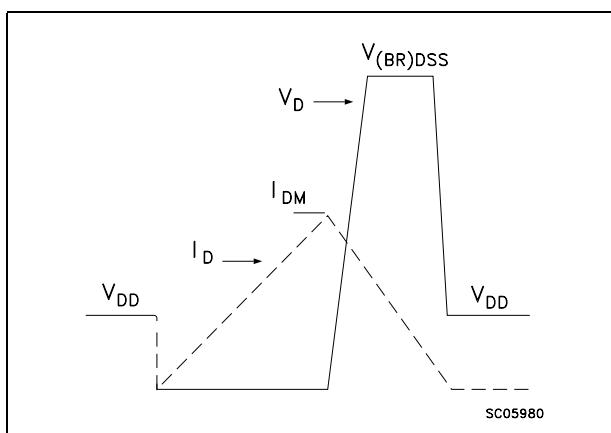
**Figure 15. Test circuit for inductive load switching and diode recovery times**



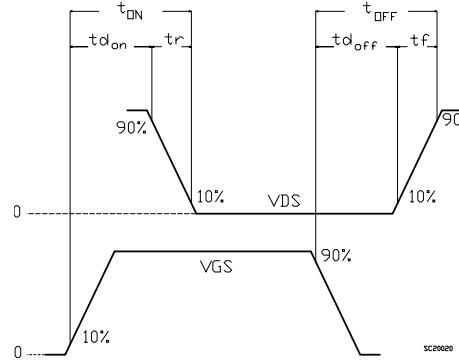
**Figure 16. Unclamped inductive load test circuit**



**Figure 17. Unclamped inductive waveform**



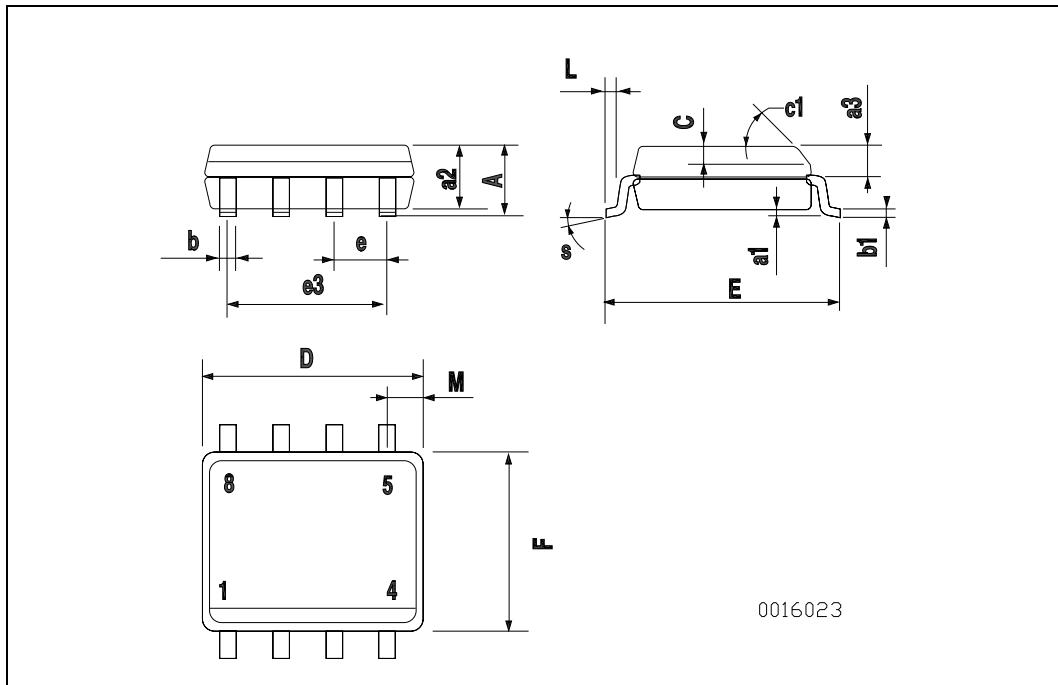
**Figure 18. Switching time waveform**



## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

SO-8 MECHANICAL DATA						
DIM.	mm.			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			1.75			0.068
a <sub>1</sub>	0.1		0.25	0.003		0.009
a <sub>2</sub>			1.65			0.064
a <sub>3</sub>	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b <sub>1</sub>	0.19		0.25	0.007		0.010
C	0.25		0.5	0.010		0.019
c <sub>1</sub>			45 (typ.)			
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e <sub>3</sub>		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
M			0.6			0.023
S			8 (max.)			



## 5 Revision history

**Table 8. Document revision history**

Date	Revision	Changes
21-Jun-2004	3	Complete document.
10-Nov-2006	4	The document has been reformatted.
31-Jan-2007	5	Typo mistake on <i>Table 2</i> .
03-May-2007	6	$R_{DS(on)}$ Max value has been changed.
03-Nov-2009	7	Updated marking in <i>Table 1</i> .

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